# 2118903-1 ACTIVE

TE Internal #: 2118903-1

Chip Antenna, Multi Band, Cellular / ISM / Cat-M/NB-IoT, Internal /Embedded Mount, Surface Mount, Omnidirectional, Single Port,

Gain > 6 dBi

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#### Antennas



Wireless Application: Bluetooth, Cat-M/NB-IoT, Cellular, ISM, LoRaWAN, LPWA, Wi-Fi

Mounting Location: Internal/Embedded

Mounting Type: Surface Mount

Antenna Type: Chip

Directionality: Omnidirectional

## **Features**

## **Configuration Features**

Antenna Style	PCB
Mounting Location	Internal/Embedded
Antenna Type	Chip
Band Type	Multi Band
Port Configuration	Single Port

#### **Electrical Characteristics**

Antenna Operation	Passive
VSWR (Max)	<3:1
Impedance	50 Ω

## Signal Characteristics

Gain (Max)	223 dB
Frequency Band	698 – 960 MHz, 1710 – 2170 MHz, 2300 – 2700 MHz
Nominal Frequency Range	698 – 2700
Peak Gain	> 6 dBi



# **Body Features**

Product Weight	3 g[.106 oz]
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### Mechanical Attachment

Polarization	Linear
Mounting Type	Surface Mount

#### **Dimensions**

Product Width	11.9 mm[.468 in]
Product Length	75 mm[2.952 in]
Product Height	1.64 mm[.064 in]

# Operation/Application

Directionality

Wireless Standard	LTE, UMTS, US Dual, EU Triband &
	WCDMA

Omnidirectional

# Industry Standards

Wireless Application	Bluetooth, Cat-M/NB-IoT, Cellular, ISM, LoRaWAN, LPWA, Wi-Fi
Primary Application	Cat-M/NB-IoT, Cellular, ISM

# **Product Availability**

# **Packaging Features**

## Other

# **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2023 (233) Candidate List Declared Against: JAN 2023 (233) Does not contain REACH SVHC



Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per
	homogenous material. Also BFR/CFR/PVC
	Free

Solder Process Capability

Reflow solder capable to 245°C

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# Compatible Parts





















# **Customers Also Bought**

















### **Documents**

## **Product Drawings**

LTE/Cell Band Antenna

English

## **CAD Files**

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_2118903-1\_A1.2d\_dxf.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_2118903-1\_A1.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_2118903-1\_A1.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

## Datasheets & Catalog Pages

PCB Ant. SMD, WORLD BAND

English

# **Product Specifications**

**Product Specification** 

English